

DATASHEET

General Description

The XLH is an HCMOS Crystal Oscillator with 750fs typical phase jitter over 12kHz to 20 MHz bandwidth. Available in a wide frequency range from 0.750MHz to 250MHz, the IDT XLH Series Crystal Oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XLH is an excellent choice over the conventional technologies. The XLH has stabilities as tight as ±20ppm with extremely quick delivery for both standard and custom frequencies

Features

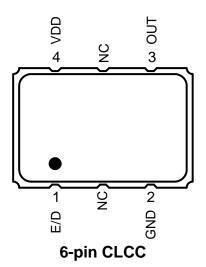
- Frequency range: 0.750 to 250 MHz
- Output Type: HCMOS/LVCMOS Compatible
- Frequency Stability: ± 20ppm, ± 25ppm, ± 50ppm, or ± 100 ppm
- Supply Voltage: 2.5V or 3.3V
- Phase Jitter (1.875MHz to 20MHz): 225fs typical
- Phase Jitter (12kHz to 20MHz): 750fs typical
- Package options: 3.2mm x 2.5mm x 1.0mm (JX4)

5.0mm x 3.2mm x 1.2mm (JS4)

7.0mm x 5.0mm x 1.3mm (JU4)

Operating Temperatures: -20°C to +70°C or -40°C to +85°C

Pin Assignment



Pin Descriptions

Pin Number	Pin Name	Description
1	E/D	Enable/Disable ¹ (0=Output Disabled)
2	GND	Connect to ground
3	OUT	Output
4	VDD	Supply voltage

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^{1.} Pulled high internally.



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XLH. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0 V
E/D	-0.5 V to VDD + 0.5 V
OUT	-0.5 V to VDD + 0.5 V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

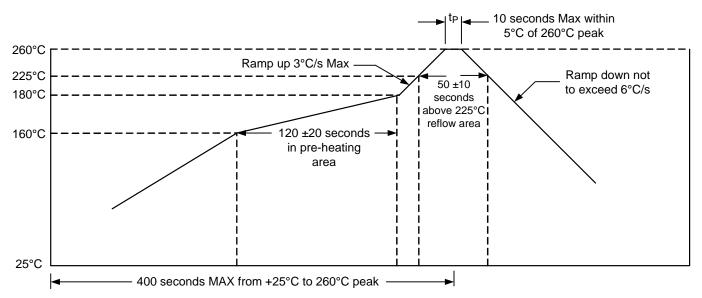
ESD Compliance

Human Body Model (HBM	1000V
Machine Model (MM)	150V

Mechanical Testing

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface–3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 minute sweep 2 hours each in 3 directions (X, Y, Z)
High Temperature Burn-in	Under power @ 125°C for 2000 hours
Hermetic Seal	He pressure: 4 ±1kgf/cm ² 2 hour soak

Solder Reflow Profile





DC Characteristics

 $(V_{DD}= 3.3 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Standard Frequencies			55	mA
Output HIGH Voltage	V _{OH}	Fout = 0.750 to 150MHz Fout = 150+ to 250MHz	90%V _{DD} 80%V _{DD}			V
Output LOW Voltage	V _{OL}	Fout = 0.750 to 150MHz Fout = 150+ to 250MHz			10%V _{DD} 20%V _{DD}	٧
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 4 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD} = 3.3 V \pm 5\%, T_A = -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		250	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Aging (1 st year)		Ta = 25°C			±3	
Aging (10 years)		Ta = 25°C			±10	
Output Load					15	pF
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{DD}			3	ns
Output Fall Time		80% to 20% V _{DD}			3	ns
Duty Cycle	T _{DTCY}	@ 50% V _{DD}	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 125MHz		3		psec
Random Jitter	R _J	Frequency = 125MHz		1.2		psec
Deterministic Jitter	DJ	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		8		psec
Total Jitter	TJ	onto and digital addity specifications)		25.2		psec
Phase Jitter (12kHz – 20MHz)	Ф _{JITTER}	Frequency = 125MHz		0.75		psec
Phase Noise Performance	ф _{NOISE}	100Hz of Carrier		-95		dBc/Hz
Frequency = 125 MHz		1kHz of Carrier		-118		dBc/Hz
		10kHz of Carrier		-120		dBc/Hz
		100kHz of Carrier		-124		dBc/Hz
		1MHz of Carrier		-143		dBc/Hz
		10MHz of Carrier		-153		dBc/Hz
Output Frequency (Standards)	F _{OUT}	10MHz of Carrier				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices



DC Characteristics

 $(V_{DD}= 2.5 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Standard Frequencies			35	mA
Output HIGH Voltage	V _{OH}	Fout = 0.750 to 160MHz Fout = 160+ to 180MHz	10%V _{DD} 20%V _{DD}			V
Output LOW Voltage	V _{OL}	Fout = 0.750 to 160MHz Fout = 160+ to 180MHz			10%V _{DD} 20%V _{DD}	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 4 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD} = 2.5 \text{ V} \pm 5\%, T_A = -20^{\circ}\text{C to } +70^{\circ}\text{C}; -40^{\circ} \text{ to } +85^{\circ}\text{C})$

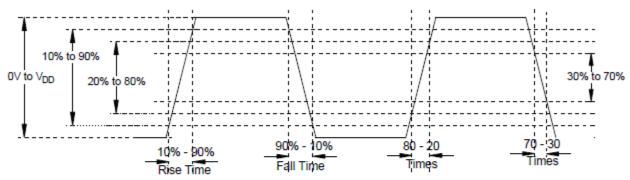
Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		180	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Output Load					15	pF
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{DD}			3	ns
Output Fall Time		80% to 20% V _{DD}			3	ns
Duty Cycle	T _{DTCY}	@ 50% V _{DD}	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 125MHz		3.3		psec
Random Jitter	R _J	Frequency = 125MHz		1.3		psec
Deterministic Jitter	DJ	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		6.7		psec
Total Jitter	TJ	omer and eight duality opcomeduction		25.6		psec
Phase Jitter (12kHz – 20MHz)	φ _{JITTER}	Frequency = 125MHz		0.85		psec
Phase Noise Performance	φ _{NOISE}	100Hz of Carrier		-91		dBc/Hz
Frequency = 125 MHz		1kHz of Carrier		-107		dBc/Hz
		10kHz of Carrier		-117		dBc/Hz
		100kHz of Carrier		-123		dBc/Hz
		1MHz of Carrier		-140		dBc/Hz
		10MHz of Carrier		-149		dBc/Hz
Output Frequency (Standards)	F _{OUT}	10MHz, 12MHz, 12.288MHz, 16MHz, 20MHz, 24MHz, 24.576MHz, 25MHz, 33.333MHz, 40MHz, 48MHZ, 50MHz, 100MHz, 125MHz, 156.25MHz (Contact IDT for additional frequencies)				

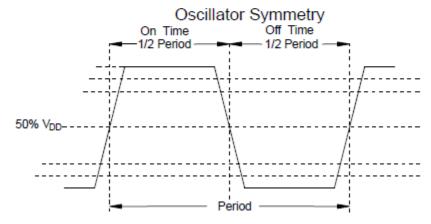
Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices



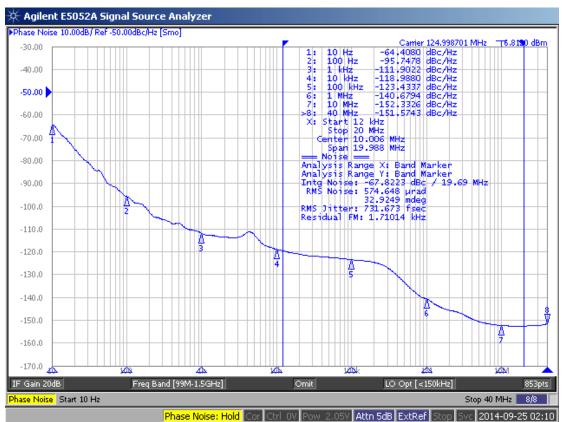
Output Waveform





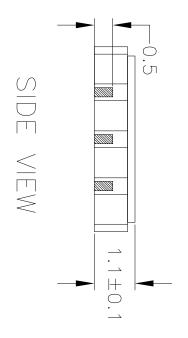


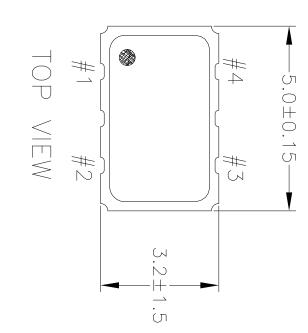
Typical Phase Noise (3.3V)



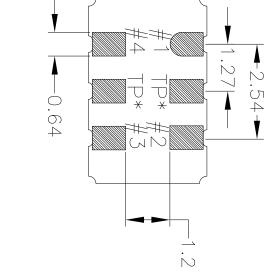


JS4 Package Outline and Dimensions





BOTTOM VIEW



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SHFFT 1 OF 2				6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674
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NOTES:

1. ALL DIMENSIONS IN MM.



JS4 Package Outline and Dimensions (cont.)

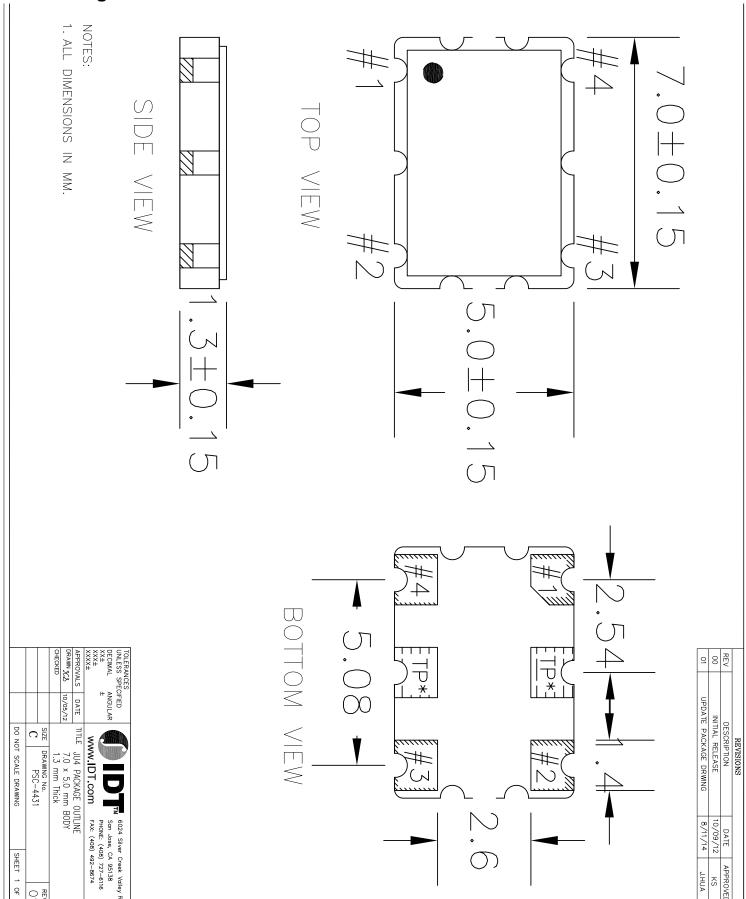
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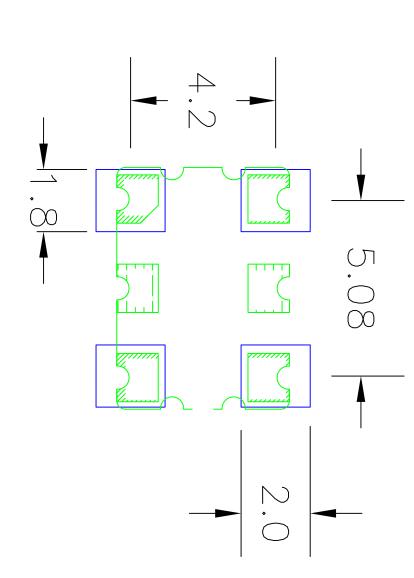


JU4 Package Outline and Dimensions





JU4 Package Outline and Dimensions (cont.)



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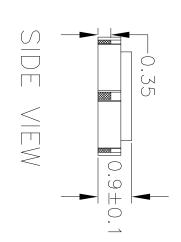
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SHEET 2 OF						FAX: (408) 492-8674	PHONE: (408) 727-6116	San Jose, CA 95138	6024 Silver Creek Valley
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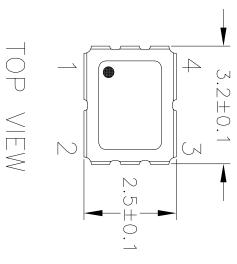


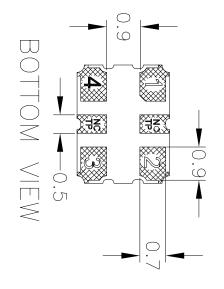
JX4 Package Outline and Dimensions

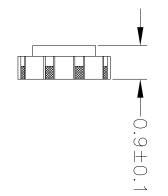
1. ALL DIMENSIONS IN MM.

NOTES:









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JX4 Package Outline and Dimensions (cont.)

FOR SURFACE MOUNT DESIGN AND LAND PATTERN. -7351B

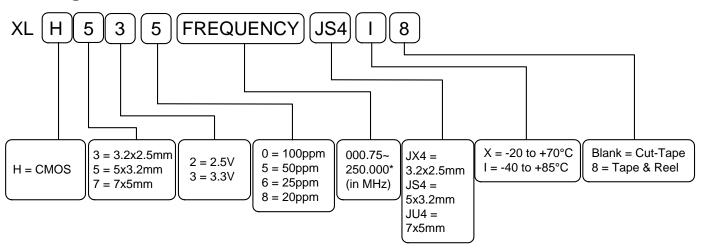
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Ordering Information



^{*} See table or contact IDT for custom frequencies

Revision History

Rev.	Date	Originator	Description of Change
Α	10/01/14	B. Chandhoke	 Corrected typo in spec for Enable/Disable Low Voltage; from ≥30%VDD to ≤30%VDD. Moved from Advance to Preliminary.
В	12/10/14	B. Chandhoke	Added 7 x 5 x 1.3mm JU4 and 3.2 x 2.5 x 1.0mm JX4 package options and package dimension/landing pattern drawings. Updated ordering information table/graphic to show added package options.



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